DB4J310K

Silicon epitaxial planar type

For high speed switching circuits DB2J310 in SMini4 type package

■ Features

- Short reverse recovery time t_{rr}
- Low forward voltage V_F
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

■ Marking Symbol: 4A

■ Basic Part Number

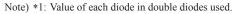
Dual DB2J310 (Parallel)

■ Packaging

DB4J310K0R Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

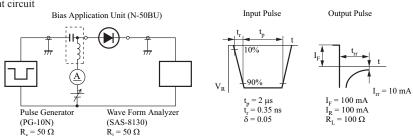
■ Absolute Maximum Ratings $T_a = 25$ °C

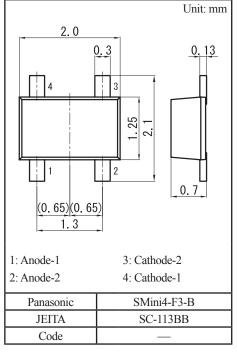
Parameter	Symbol	Rating	Unit	
Reverse voltage		V _R	30	V
Repetitive peak reverse voltage		V _{RRM}	30	V
Forward current (Average)	Single	T	200	mA
	Double *1	$I_{F(AV)}$	150	mA
Peak forward current	Single	т	300	mA
	Double *1	I_{FM}	225	mA
Non-repetitive peak forward surge current *2		I _{FSM}	1	A
Junction temperature		T _j 125		°C
Storage temperature		T _{stg}	-55 to +125	°C

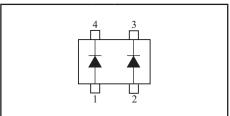


*2: 50 Hz sine wave 1 cycle (Non-repetitive peak current)									
■ Electrical Characteristics T _a = 25°C±3°C									
Parameter	Symbol	Conditions	Min	Тур	Max	Unit			
Forward voltage	V_{F1}	$I_F = 5 \text{ mA}$			0.27	V			
	V_{F2}	$I_F = 100 \text{ mA}$			0.40				
	V_{F3}	$I_F = 200 \text{ mA}$			0.47				
Reverse current	I_{R1}	$V_R = 10 \text{ V}$			20	μΑ			
	I_{R2}	$V_R = 30 \text{ V}$			200				
Terminal capacitance	C _t	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		4.5		pF			
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}, I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$		1.6		ns			

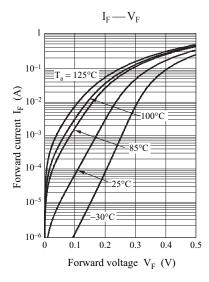
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 250 MHz
 - *: t_{rr} measurement circuit

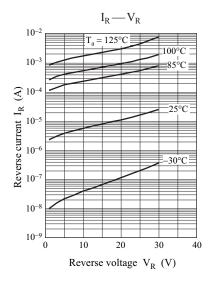


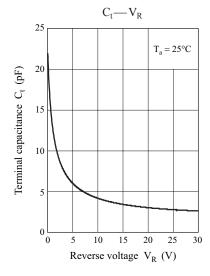




DB4J310K Panasonic



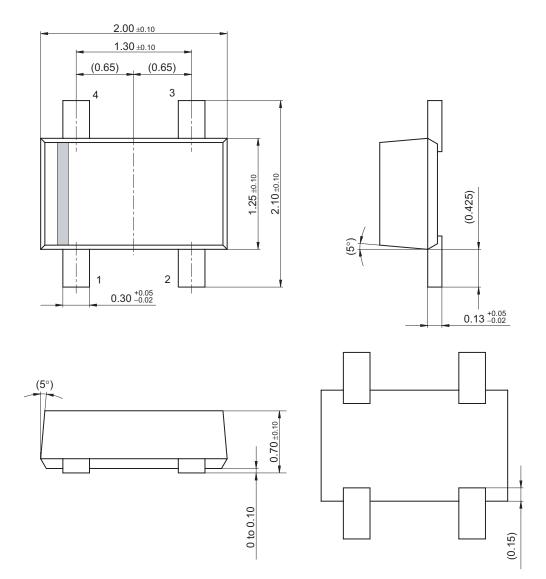




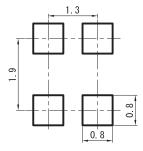
2 Ver. DED

SMini4-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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